

EAST - [10660102.wsp:1]

File View Edit Tools Window Help

Drafts
Pending
Active
L1: (407) (chip near on near film COF) and ((substrate insulating near tape) with (heat\$3 pre-he...
L2: (5) (chip near on near film COF) and ((insulating near tape) with (heat\$3 pre-heat\$3 cure cu...
L3: (2) ((chip near on near film COF) and ((insulating near tape) with (heat\$3 pre-heat\$3 cure c...
L4: (5) ((chip near on near film COF) and ((insulating near tape) with (heat\$3 pre-heat\$3 cure c...
Failed
Saved
Favorites
Tagged (0)
UDC
Queue
Trash

Browse Queue
DBs Plurals
Default open Highlight all hit terms initially

((chip near on near film COF) and
((insulating near tape) with (heat\$3
pre-heat\$3 cure curing light\$3))) and
resin

BR... IS... Test HTML

	U	I	Document ID	Issue Date	Pages	Title	Current OR	Current XRef	R
1	<input type="checkbox"/>	<input type="checkbox"/>	US 20040063332 A1	20040401	14	COF semiconductor device and a manufacturing method for the same	438/734		
2	<input type="checkbox"/>	<input type="checkbox"/>	US 20010008303 A1	20010719	31	Semiconductor apparatus, a method of fabrication of the same, and a reinforcing	257/666	257/668; 257/670;	
3	<input type="checkbox"/>	<input type="checkbox"/>	US 6740966 B2	20040525	31	Semi-conductor apparatus, a method of fabrication of the same, and a reinforcing	257/701	257/668; 257/678;	
4	<input type="checkbox"/>	<input type="checkbox"/>	US 6313526 B1	20011106	29	Semiconductor apparatus, Including thin film belt-like insulating tape	257/706	206/714; 206/716;	
5	<input type="checkbox"/>	<input type="checkbox"/>	JP 2004128337 A	20040422	11	COF SEMICONDUCTOR DEVICE AND ITS MANUFACTURING METHOD			